### **HSMP-389Z**

# RF Switching PIN Diodes In Surface Mount SOD-323 Package



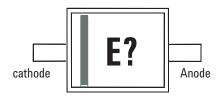
## **Data Sheet**

### **Description/Applications**

Avago Technologies's HSMP-389Z is optimized for switching applications where low resistance at low current and low capacitance are required. It is housed in a low cost, industrial standard surface mount package - SOD-323. This package offers customers who already use them in SOT-23 and SOT-323 packages, a logical transition to a smaller package outline to accommodate end product design with limited board space.

A SPICE model is not available for PIN diodes as SPICE does not provide for a key PIN diode characteristic -- carrier lifetime.

### **Package Marking and Pin Connections**



#### Note:

Package marking provides orientation and identification

"E" = Device Code

"?" = Month code indicates the month of manufacture

#### **Features**

- 2 Leads Surface Mount Package
- Switching
  - Low Capacitance
  - Low Resistance at Low Current
- Tape and Reel Options Available
- Low Failure in Time (FIT) Rate
- MSL 1 & Lead Free

Table 1. Absolute Maximum Ratings [1] at  $Tc = +25^{\circ}C$ 

Symbol	Parameter	Unit	Max Rating
I <sub>f</sub>	Forward Current (1 µs Pulse)	Amp	1
P <sub>IV</sub>	Peak Inverse Voltage	V	100
T <sub>i</sub>	Junction Temperature	0C	150
T <sub>stg</sub>	Storage Temperature	0C	-60 to 150
$\theta_{jb}$	Thermal Resistance <sup>[2]</sup>	°C/W	135

#### Notes:

- 1. Operation in excess of any one of these conditions may result in permanent damage to the device.
- 2. Thermal Resistance is measured from junction to board using IR method.

Table 2. Electrical Specifications at  $Tc = +25^{\circ}C$ 

	Minimum Breakdown Voltage V <sub>BR</sub> (V)	$\begin{array}{c} \textbf{Maximum Total Resistance} \\ \textbf{R}_s \ (\textbf{Ohm}) \end{array}$	$\begin{array}{c} \text{Maximum Total Capacitance} \\ \textbf{C}_{\text{T}} \text{ (pF)} \end{array}$
	100	2.5	0.30
Test Conditions	$V_R = V_{BR}$ Measure $I_R \le 10uA$	I <sub>F</sub> = 5mA f = 100 MHz	$V_R = 5V$ f = 1MHz

Note: Rs parameter is tested under AQL 1.0

Table 3. Typical Parameters at  $Tc = +25^{\circ}C$ 

	Series Resistance R <sub>s</sub> (Ohm)	Carrier Lifetime τ (ns)	Total Capacitance C <sub>T</sub> (pF)
	3.8	200	0.20
Test Conditions	I <sub>F</sub> = 1 mA f = 100 MHz	$I_F = 10 \text{mA}$ $I_R = 6 \text{mA}$	$V_R = 5V$ f = 1 MHz

### Typical Performance Curves at $Tc = +25^{\circ}C$

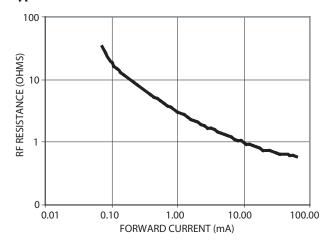


Figure 1. RF Resistance vs. Forward Bias Current

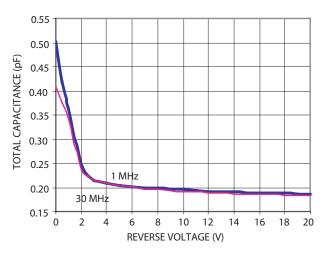


Figure 3. RF Capacitance vs. Reverse Bias

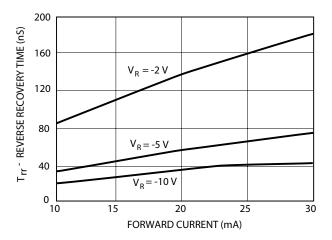


Figure 5. Typical Reverse Recovery Time vs. Reverse Voltage

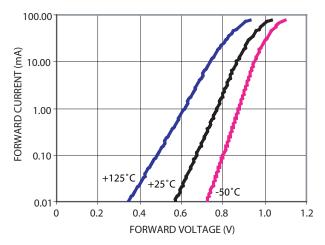


Figure 2. Forward Current vs. Forward Voltage

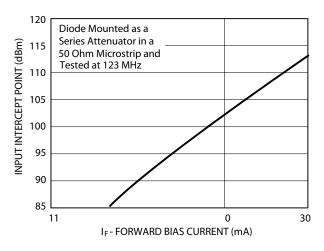
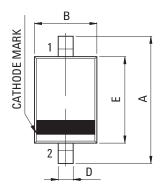
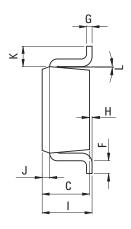


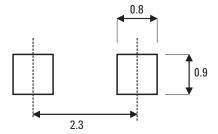
Figure 4. 2nd Harmonic Input Intercept Point vs. Diode RF Resistance

## **Package Outline and Dimension**

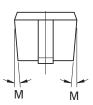




## **PCB Footprint**

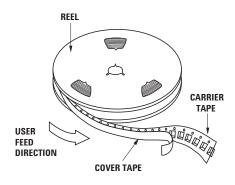


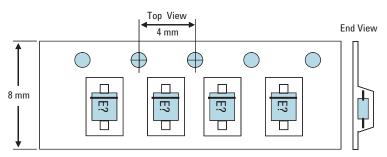
Dimension in mm



DIM	MILLIMETERS
Α	2.50 ±0.2
В	1.25 ±0.05
С	0.90 ±0.05
D	0.30+0.06/-0.04
Е	1.70 ±0.05
F	MIN 0.17
G	0.126 ±0.03
Н	0~0.1
ı	1.0 MAX
J	0.15 ±0.05
K	0.4
L	2°+4/-2
M4	~6°

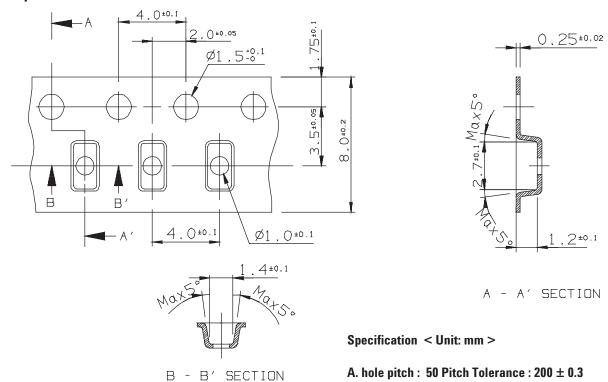
### **Device Orientation**





Note: "E" represents package marking code "?" represents date code

### **Tape Dimensions**



## **Part Number Ordering Information**

Part number	No. of Units	Container
HSMP-389Z-BLKG	100	Anti-static bag
HSMP-389Z-TR1G	3000	7" reel

For product information and a complete list of distributors, please go to our web site:

www.avagotech.com

